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MEMBERSHIP

November 10, 2026

To whom it may concern,

Company name: Mitsui Kinzoku Co., Ltd.
Name of representative: IKENOBU Seiji,
Representative Director, President, CEO and COO
(Securities code: 5706; TSE Prime Market)
Inquiries: SHIRAISHI Katsumi,
General Manager of
Corporate Communications Department
(Telephone: +81-3-5437-8028)

Notice Concerning the Construction of a New Copper Foil Plant in Malaysia (Acquisition of Fixed Assets)

Mitsui Kinzoku Co., Ltd. (the "Company") hereby announces that its Board of Directors, at a meeting held today, resolved to construct a new copper foil plant in Malaysia and acquire related fixed assets, as outlined below.

1. Purpose of Constructing the New Plant

To ensure the continued stable supply of its copper foil products to customers amid the anticipated continued rapid growth of the AI and semiconductor markets, the Company has decided to construct a new copper foil plant in Malaysia.

2. Overview of the New Plant

(1) Location

Malaysia (near Mitsui Copper Foil (Malaysia) SDN. BHD., a consolidated subsidiary of the Company)

(2) Details of the Investment

Manufacturing equipment for "MicroThin™" carrier-supported ultra-thin copper foil and "VSP™" electrodeposited copper foil for high-frequency circuit boards, as well as the related land and buildings

(For Reference)

Upper row: Increase in production capacity attributable to the new plant

Lower row: Total production capacity across all sites after the addition of the new plant's capacity

	FY2031	FY2032	FY2033	Total production capacity increase over three years
MicroThin™ (10,000 m^2 / month)	+200 1,000	- 1,000	+200 1,200	+400
VSP™ (tons/month)	+600 2,000	+600 2,600	- *2,600	+1,200

* The site to be acquired can accommodate production capacity of up to 3,600 t/month. As the market continues to expand, we will also consider establishing a combined production capacity of 5,000 t/month across this and other sites.

(3) Total Investment

Approximately JPY 190 billion (of which, approximately JPY 14 billion for land, JPY 32 billion for buildings, and JPY 144 billion for production equipment and other assets)

(4) Financing

The investment will be funded through cash on hand, borrowings, and other sources.

(5) Commencement of operations

Operations will commence in phases from April 2031.

3. Future Outlook

The impact of this matter on the Company’s consolidated financial results for the fiscal year ending March 31, 2027, is expected to be immaterial. Through investments planned through FY2030 and this investment, operating profit from the Company’s copper foil business, which is included in the Engineered Materials segment, is expected to reach 3.2 times the FY2025 level in FY2030 and 5.5 times in FY2033. This investment is expected to contribute to profit growth from FY2031 onward. The Company will promptly disclose any matters requiring disclosure as they arise.